Special Issue

Artificial Intelligence Applications in Medical Data Analysis and Healthcare Virtual Assistants

Message from the Guest Editor

This Special Issue is intended to be a forum for sharing the latest advancements and exploratory research in the integration of Artificial Intelligence (AI) within the medical and healthcare domains. We seek innovative research that leverages Al. Natural Language Processing (NLP). Large Language Models (LLMs), and comprehensive data architectures to foster the development of medical devices and virtual assistants in healthcare. Contributions are encouraged in areas such as data engineering and data science that underscore the enhancement of healthcare outcomes. Through this confluence of technologies and methodologies, our objective is to spotlight groundbreaking approaches and technologies that pave the way for a transformative impact on patient care, medical procedures, and the overall healthcare ecosystem.

Guest Editor

Dr. Jordi Cusido

Departament de Projectes i Construcció, Universitat Politècnica de Catalunya, Barcelona, Spain

Deadline for manuscript submissions

20 August 2025



Applied Sciences

an Open Access Journal by MDPI

Impact Factor 2.5 CiteScore 5.5



mdpi.com/si/189760

Applied Sciences Editorial Office MDPI, Grosspeteranlage 5 4052 Basel, Switzerland Tel: +41616837734 applsci@mdpi.com

mdpi.com/journal/applsci





Applied Sciences

an Open Access Journal by MDPI

Impact Factor 2.5 CiteScore 5.5



About the Journal

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo

Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy

Author Benefits

Open Access:

free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility:

indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, CAPlus / SciFinder, and other databases.

Journal Rank:

JCR - Q2 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)

